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Vishay Siliconix

COMPLIANT

FREE

P-Channel 100 V (D-S) 175 °C MOSFET

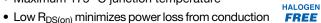


PRODUCT SUMMARY						
V _{DS} (V)	-100					
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.0101					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5 \text{ V}$	0.0150					
Q _g typ. (nC)	125					
I _D (A)	-120					
Configuration	Single					

FEATURES

- TrenchFET® power MOSFET
- · Package with low thermal resistance

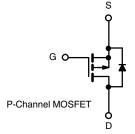




- · Compatible with logic-level gate driving
- 100 % Rq and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Battery protection
- Motor drive control
- Load switch



ORDERING INFORMATION						
Package	TO-263					
Lead (Pb)-free and halogen-free	SUM70101EL-GE3					
ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-source voltage		V_{DS}	-100			
Gate-source voltage	V_{GS}	± 20	V			
Continuous drain current ^d	T _C = 25 °C	I _D	-120			
(T _J = 175 °C)	T _C = 125 °C		-78			
Pulsed drain current (100 μs)	I _{DM}	-240	Α			
Avalanche current	L = 0.1 mH	I _{AS}	-75			
Single pulse avalanche energy ^a	L = 0.1 mn	E _{AS}	281	mJ		
Power dissipation	T _C = 25 °C °	В	375	W		
Power dissipation	T _C = 125 °C b	P_D	125	VV		
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +175	°C			

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	UNIT		
Junction-to-ambient	PCB mount ^b	R_{thJA}	40	°C/W		
Junction-to-case		R_{thJC}	0.4	C/W		

Notes

- a. Duty cycle ≤ 1 %
- b. When mounted on 1" square PCB (FR4 material)
- c. See SOA curve for voltage derating
- d. Limited by package



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PARAMETER SY		TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		-	-		
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	-1.5	-	-2.5	V	
Gate-body leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	_	± 100	nA	
		V _{DS} = -100 V, V _{GS} = 0 V	-	-	-1		
Zero gate voltage drain current	I _{DSS}	V _{DS} = -100 V, V _{GS} = 0 V, T _J = 125 °C	-	-	-50	μΑ	
		V _{DS} = -100 V, V _{GS} = 0 V, T _J = 175 °C	-	-	-250		
On-state drain current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	-120	-	-	Α	
Drain accuracy on state registeres 2	В	$V_{GS} = -10 \text{ V}, I_D = -30 \text{ A}$	-	0.0081	0.0101		
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -20 \text{ A}$	-	0.0114	0.0150	Ω	
Forward transconductance ^a	9fs	V _{DS} = -15 V, I _D = -25 A	-	60	-	S	
Dynamic ^b	_						
Input capacitance	C _{iss}			7000	=	pF	
Output capacitance	Coss	$V_{GS} = 0 \text{ V}, V_{DS} = -50 \text{ V}, f = 1 \text{ MHz}$	-	2180	-		
Reverse transfer capacitance	C _{rss}		-	170	-		
Total gate charge ^c	Qg		-	125	190		
Gate-source charge ^c	Q _{gs}	$V_{DS} = -50 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -110 \text{ A}$	=.	29	-	nC	
Gate-drain charge ^c	Q_{gd}		-	30	-		
Gate resistance	R _g	f = 1 MHz	1.3	6.5	13	Ω	
Turn-on delay time ^c	t _{d(on)}		=	20	30		
Rise time ^c	t _r	$V_{DD} = -50 \text{ V}, R_L = 0.71 \Omega$	=	40	60	ns	
Turn-off delay time ^c	t _{d(off)}	$I_D \cong -70 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	110	200		
Fall time ^c	t _f		=.	40	60		
Drain-Source Body Diode Characte	ristics (T _C = 25	5 °C b)					
Continuous current	I _S		-	-	-110	Α	
Pulsed current	I _{SM}		-	-	-240	A	
Forward voltage ^a	V _{SD}	$I_F = -85 \text{ A}, V_{GS} = 0 \text{ V}$	-	-1	-1.5	V	
Reverse recovery time	t _{rr}		-	110	170	ns	
Peak reverse recovery charge	I _{RM(REC)}	I _F = -85 A, dI/dt = 100 A/μs	-	-7	-11	Α	
Reverse recovery charge	Q _{rr}		-	0.38	0.57	μC	

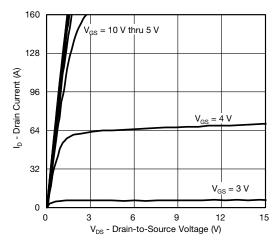
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

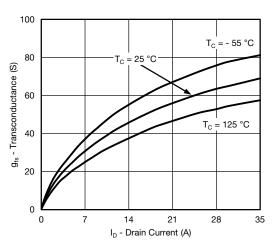
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



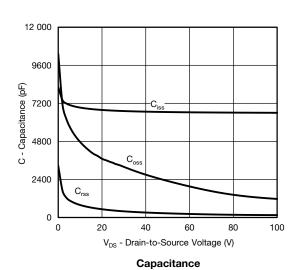
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

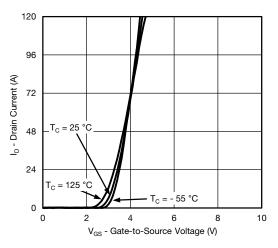


Output Characteristics

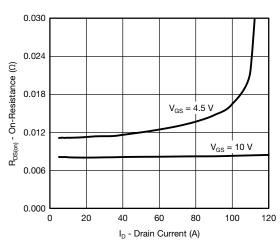


Transconductance

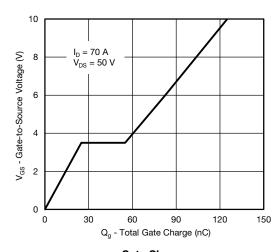




Transfer Characteristics

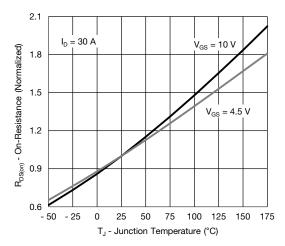


On-Resistance vs. Drain Current

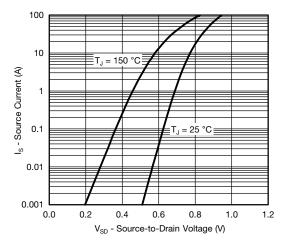




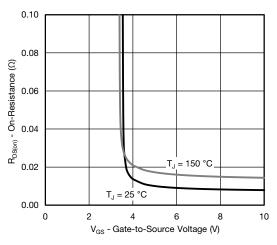
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



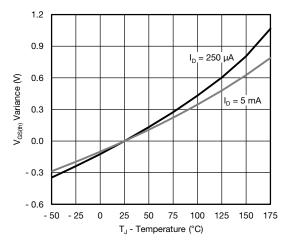
On-Resistance vs. Junction Temperature



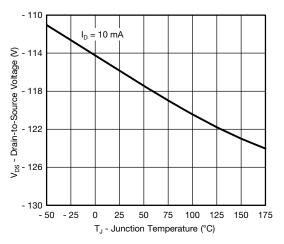
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



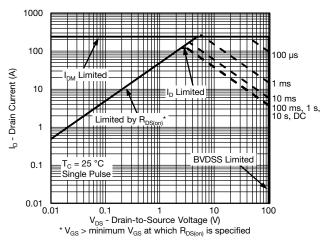
Threshold Voltage



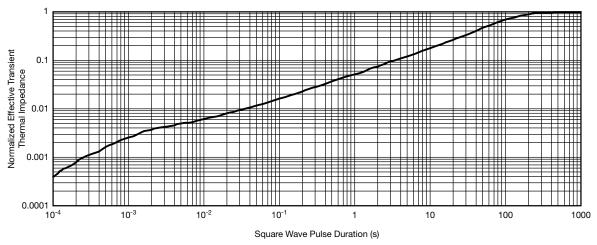
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



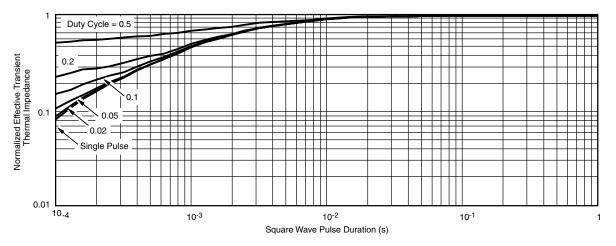
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

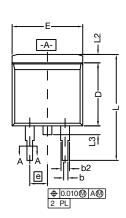
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Case (25 °C)

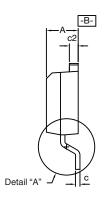
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

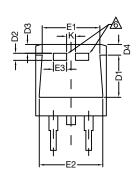
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg277605.



TO-263 (D²PAK): 3-LEAD

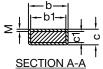








DETAIL A (ROTATED 90°)



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2:	П			<u>T</u>	5	ပ
,	SE	СТ	ION	ΙΔ-	Ι.Δ	t

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6 This feature is for thick lead.

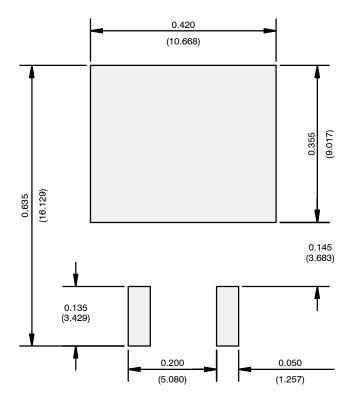
		INCHES		MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
Α		0.160	0.190	4.064	4.826	
	b	0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
c*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
	D3	0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	Е	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	=	
	E2	0.355	0.375	9.017	9.525	
	E3	0.072	0.078	1.829	1.981	
	е	0.100) BSC	2.54 BSC		
	K	0.045	0.055	1.143	1.397	
	L	0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
	L2	0.040	0.055	1.016	1.397	
L3		0.050	0.070	1.270	1.778	
	L4 0.01) BSC	0.254 BSC		
М		-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13						

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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